PNP SILICON PLANAR EPITAXIAL TRANSISTORS



Boca Semiconductor Corp.
BSC
http://www.bocasemi.com

BC 556, A, B BC 557, 8, A, B, C TO-92 EBC

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APPLICATION

Collector-Cut off Current

PNP General Purpose Transistors, Especially Suited For Use in Driver Stages of Audio Amplifier, Low Noise Input Stages of Tape Recorders, HI-FI Amplifiers, Signal Processing Circuits of Television Receivers.

ABSOLUTE MAXIMUM RATINGS(Ta=25 deg C unless otherwise specified)

ICES

DESCRIPTION	SYMBOL		BC556	BC557	BC558	UNITS
Collector -Emitter Voltage	VCEO		65	45	30	V
Collector -Emitter Voltage	VCES		80	50	30	V
Collector -Base Voltage	VCBO		80	50	30	V
Emitter -Base Voltage	VEBO			5.0		V
Collector Current Continuous	IC			100		mA
Peak	ICM			200		mA
Base Current -Peak	IBM			200		mA
Emitter Current- Peak	IEM			200		mA
Power Dissipation@ Ta=25 degC	PTA			500		mW
Derate Above 25 deg C				4.0		mW/deg C
Storage Temperature	Tstg			-65 to +150		deg C
Junction Temperature	Tj			150		deg C
THERMAL RESISTANCE						
Junction to Ambient	Rth(j-a)			250		deg C/W
	AF 1 A 11	place Otherwice Space	ifiad)			
ELECTRICAL CHARACTERISTICS (Ta		mess Omerwise Spec	ilieu)			
DESCRIPTION	SYMBOL	TEST CONDITION	BC556	BC557	BC558	UNITS
	SYMBOL VCEO	TEST CONDITION IC=2mA,IB=0	BC556 >65	>45	>30	V
DESCRIPTION	SYMBOL	TEST CONDITION	BC556			V V
DESCRIPTION Collector -Emitter Voltage	SYMBOL VCEO	TEST CONDITION IC=2mA,IB=0	BC556 >65	>45 >50 >5.0	>30 >30 0	V
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage	SYMBOL VCEO VCBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0	BC556 >65	>45 >50	>30 >30 0	V V
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL	BC556 >65	>45 >50 >5.0	>30 >30 0	V V V
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C	BC556 >65	>45 >50 >5. <15	>30 >30 0 5	V V V nA
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO ICBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C VCB=30V, IE=0 ALL	BC556 >65 >80	>45 >50 >5.0	>30 >30 0 5	V V V nA
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C VCB=30V, IE=0 ALL VCE=80V, VBE=0	BC556 >65	>45 >50 >5. <15 <5.	>30 >30 0 5	V V V nA uA nA
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO ICBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C VCB=30V, IE=0 ALL VCE=80V, VBE=0 VCE=50V, VBE=0	BC556 >65 >80	>45 >50 >5. <15	>30 >30 0 5	V V NA uA nA
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO ICBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C VCB=30V, IE=0 ALL VCE=80V, VBE=0	BC556 >65 >80	>45 >50 >5. <15 <5.	>30 >30 0 5	V V V nA uA nA
DESCRIPTION Collector -Emitter Voltage Collector -Base Voltage Emitter-Base Voltage	SYMBOL VCEO VCBO VEBO ICBO	TEST CONDITION IC=2mA,IB=0 IC=100uA.IE=0 IE=100uA, IC=0 ALL VCB=30V, IE=0 ALL Tj=150 deg C VCB=30V, IE=0 ALL VCE=80V, VBE=0 VCE=50V, VBE=0	BC556 >65 >80	>45 >50 >5. <15 <5.	>30 >30 0 5	V V NA uA nA

VCE=80V, VBE=0

VCE=50V, VBE=0

VCE=30V, VBE=0

<4.0

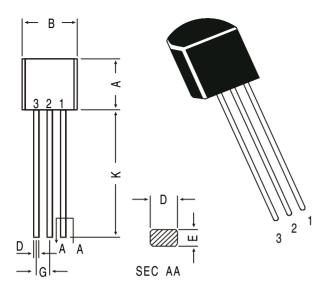
<4.0

<4.0

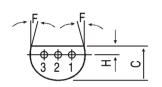
DESCRIPTION	SYMBOL	TEST CONDITION		VALUE	UNITS
DC Current Gain	hFE	IC=10uA,VCE=5V	Α	typ90	
			В	typ150	
			С	typ270	
		IC=2mA,VCE=5V	BC556	75-475	
			BC557,8	75-800	
			Α	110-220	
			В	200-450	
			С	420-800	
		IC=100mA,VCE=5V	Α	typ120	
			В	typ200	
			С	typ400	
Collector Emitter Saturation Voltage	VCE(Sat)	IC=10mA,IB=0.5mA		< 0.30	V
_		IC=100mA,IB=5mA		<0.65	V
Base Emitter Saturation Voltage	VBE(Sat)	IC=10mA,IB=0.5mA		typ0.70	V
_		IC=100mA,IB=5mA		typ0.90	V
Base Emitter on Voltage	VBE(on)	IC=2mA,VCE=5V		0.55-0.70	V
5	` ,	IC=10mA,VCE=5V		<0.82	V
DYNAMIC CHARACTERISTICS					
Transistors Frequency	ft	IC=10mA, VCE=5V f=100MHz		typ150	MHz
Collector out-put Capacitance	Ccbo	VCB=10V, f=1MHz		<6.0	pF
Emitter Input Capacitance	Cib	VEB=0.5V, f=1MHz		typ9.0	pF
Noise Figure	NF	IC=0.2mA, VCE=5V		<10	dB
•		Rs=2kohm, f=1kHZ			
		B=200Hz			
		ALL f=1KHz			
Small Signal Current Gain	hfe	IC=2mA, VCE=5V	Α	typ220	
			В	typ330	
			С	typ600	
Input Impedance	hie	IC=2mA, VCE=5V	Α	1.6-4.5	khoms
			В	3.2-8.5	
			С	6.0-15	
Voltage Feedback Ratio	hre	IC=2mA, VCE=5V	Α	typ1.5	X`10-4
			В	typ2.0	
			С	typ3.0	
Out put Adimttance	hoe	IC=2mA, VCE=5V	Α	<30	umhos
			В	<60	
			С	<110	

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TO-92 Plastic Package



All diminsions in mm.

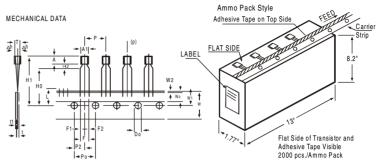


PIN CONFIGURATION

- 1. EMITTER
- 2. BASE
- 3. COLLECTOR

DIM	MIN.	MAX.		
Α	4.32	5.33		
В	4.45	5.20		
С	3.18	4.19		
D	0.41	0.55		
Е	0.35	0.50		
F	5 DEG			
G	1.14	1.40		
Н	1.14	1.53		
K	12.70	_		

TO-92 Transistors on Tape and Ammo Pack



All dimensions in mm unless specified otherwise

ITEM		SPECIFICATION					
ITEM	SYMBOL	MIN.	NOM.	MAX.	TOL.	REMARKS	
BODY WIDTH	A1	4.0		4.8			
BODY HEIGHT	A T	4.8		5.2			
BODY THICKNESS	Ţ	3.9	40.7	4.2			
PITCH OF COMPONENT	Р		12.7		±1	OLIMALII ATIVE DITOLI	
FEED HOLE PITCH	Po		12.7		±0.3	CUMULATIVE PITCH ERROR 1.0 mm/20 PITCH	
FEED HOLE CENTRE TO							
COMPONENT CENTRE	P2		6.35		±0.4	TO BE MEASURED AT BOTTOM OF CLINCH	
DISTANCE BETWEEN OUTER	l _				+0.6		
LEADS	F		5.08		-0.2		
COMPONENT ALIGNMENT	Δh		0	1		AT TOP OF BODY	
TAPE WIDTH HOLD-DOWN TAPE WIDTH	W Wo		18 6		±0.5 ±0.2		
HOLE POSITION	W 0 W 1		9		±0.2 +0.7		
HOLL FOSITION	VV 1		9		-0.5		
HOLD-DOWN TAPE POSITION	W2		0.5		±0.2		
LEAD WIRE CLINCH HEIGHT	Нο		16		±0.5		
COMPONENT HEIGHT	H1			23.25			
LENGTH OF SNIPPED LEADS	L			11.0			
FEED HOLE DIAMETER	Do		4	ا ۱	±0.2		
TOTAL TAPE THICKNESS	t F2		0.54	1.2		t1 0.3 - 0.6	
LEAD - TO - LEAD DISTANCEF1,	12		2.54		+0.4 -0.1		
CLINCH HEIGHT	H2			3			
PULL - OUT FORCE	(P)	6N					

- 1. MAXIMUM ALIGNMENT DEVIATION BETWEEN LEADS NOT TO BE GREATER THAN 0.2 mm
- 3. HOLDDOWN TAPE NOT TO EXCEED BEYOND THE EDGE(S) OF CARRIER TAPE AND THERE SHALL BE NO EXPOSURE OF ADHESIVE.
- 4. NO MORE THAN 3 CONSECUTIVE MISSING COMPONENTS ARE PERMITTED.
- 5. A TAPE TRAILER, HAVING AT LEAST THREE FEED HOLES ARE REQUIRED AFTER THE LAST COMPONENT.
 6. SPLICES SHALL NOT INTERFERE WITH THE SPROCKET FEED HOLES.

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